

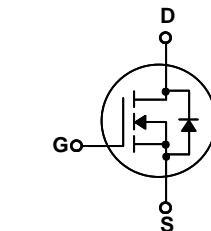
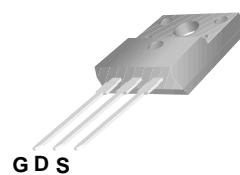


WGF18N65

650V N-Channel MOSFET

Features

- Low Intrinsic Capacitances
- Excellent Switching Characteristics
- Extended Safe Operating Area
- Unrivalled Gate Charge : $Q_g = 50\text{nC}$ (Typ.)
- $\text{BVDSS}=650\text{V}, \text{ID}=18\text{A}$
- $R_{DS(on)} : 0.42 \Omega$ (Max) @ $\text{VG}=10\text{V}$
- 100% Avalanche Tested



TO-220F

G-Gate,D-Drain,S-Source

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	WGF18N65	Units
V_{DSS}	Drain-Source Voltage	650	V
I_D	Drain Current -continuous ($T_c=25^\circ\text{C}$)	18*	A
	-continuous ($T_c=100^\circ\text{C}$)	11.4*	A
V_{GS}	Gate-Source Voltage	± 30	V
E_{AS}	Single Plused Avalanche Energy (Note1)	1020	mJ
I_{AR}	Avalanche Current (Note2)	18	A
P_D	Power Dissipation ($T_c=25^\circ\text{C}$)	95	W
T_J, T_{STG}	Operating and Storage Temperature Range	-55 ~ +150	°C
TL	Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	300	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max	Units
$R_{\theta JC}$	Thermal Resistance,Junction to Case	--	1.8	°C/W
$R_{\theta JA}$	Thermal Resistance,Junction to Ambient	--	62.5	°C/W

* Drain current limited by maximum junction temperature.

Electrical Characteristics T_c=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max	Units
Off Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	ID=250 μA, VGS=0	650	--	--	V
△BV _{DSS} / △T _J	Breakdown Voltage Temperature Coefficient	I _D =250 μA, Reference to 25°C	--	0.71	--	V/°C
IDSS	Zero Gate Voltage Drain Current	Vds=650V, Vgs=0V	--	--	10	μA
		Vds=480V, Tc=125°C			100	μA
IGSSF	Gate-body leakage Current, Forward	Vgs=+30V, Vds=0V	--	--	100	nA
IGSSR	Gate-body leakage Current, Reverse	Vgs=-30V, Vds=0V	--	--	-100	nA

On Characteristics

V _{GS(th)}	Date Threshold Voltage	Id=250uA,Vds=Vgs	2	--	4	V
R _{DS(on)}	Static Drain-Source On-Resistance	Id=9A,Vgs=10V	--	--	0.42	Ω

Dynamic Characteristics

Ciss	Input Capacitance	VDS=25V, VGS=0, f=1.0MHz	--	2500	3095	pF
Coss	Output Capacitance		--	280	385	pF
Crss	Reverse Transfer Capacitance		--	23.6	35.5	pF

Switching Characteristics

Td(on)	Turn-On Delay Time	VDD=300V, ID=18A RG=5 Ω (Note 3,4)	--	21	120	nS
Tr	Turn-On Rise Time		--	60	180	nS
Td(off)	Turn-Off Delay Time		--	62	184	nS
Tf	Turn-Off Fall Time		--	60	180	nS
Qg	Total Gate Charge	VDS=480, VGS=10V, ID=18A (Note 3,4)	--	48.5	63	nC
Qgs	Gate-Source Charge		--	15	--	nC
Qgd	Gate-Drain Charge		--	18	--	nC

Drain-Source Diode Characteristics and Maximum Ratings

I _S	Maximum Continuous Drain-Source Diode Forward Current	--	--	18	A
I _{SM}	Maximum Plated Drain-Source Diode Forward Current	--	--	64	A
V _{SD}	Drain-Source Diode Forward Voltage	--	--	1.5	V
trr	Reverse Recovery Time	--	200	--	nS
Qrr	Reverse Recovery Charge	--	3.69	--	μC

*Notes 1, L=11.1mH, IAS=18A, VDD=50V, RG=25Ω, Starting TJ =25°C

2, Repetitive Rating : Pulse width limited by maximum junction temperature

3, Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 2%

4, Essentially Independent of Operating Temperature

Typical Characteristics

Figure 1. On-Region Characteristics

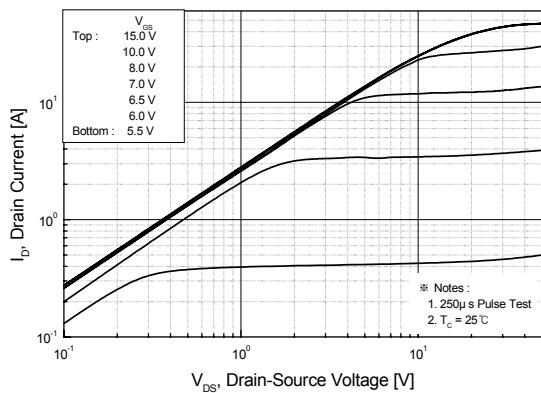


Figure 2. Transfer Characteristics

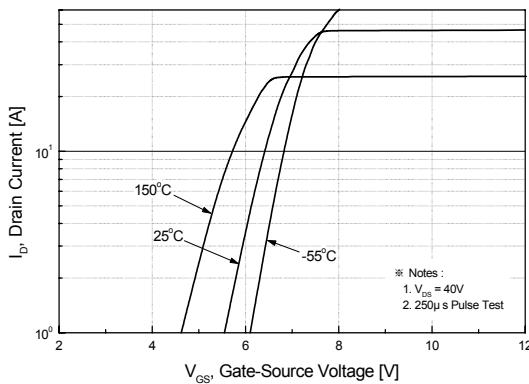


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

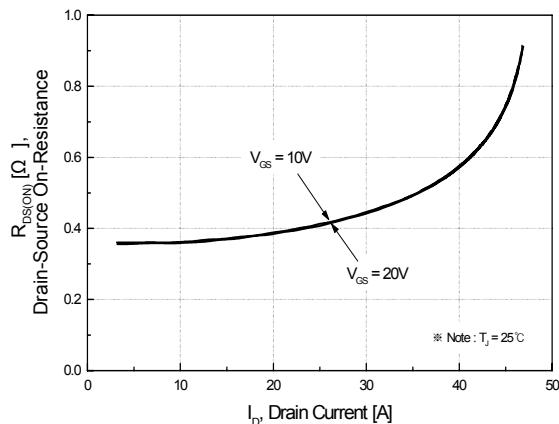


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

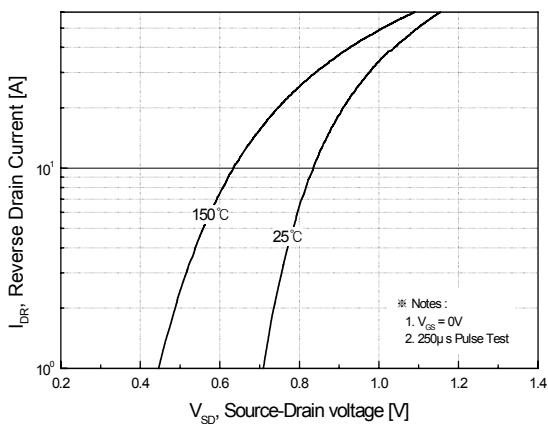


Figure 5. Capacitance Characteristics

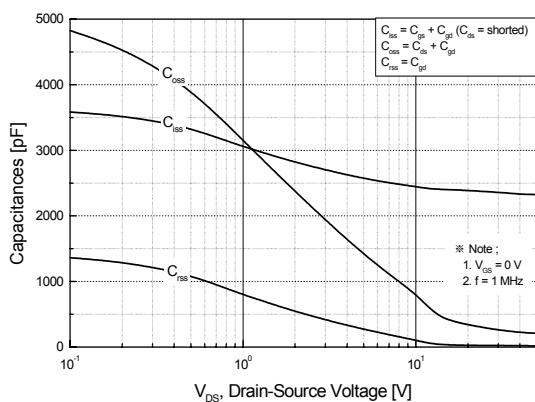
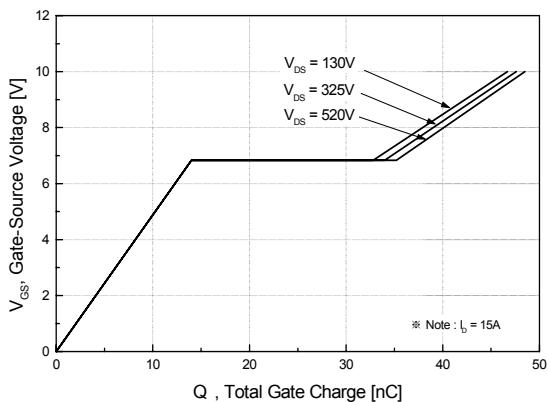


Figure 6. Gate Charge Characteristics



Typical Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

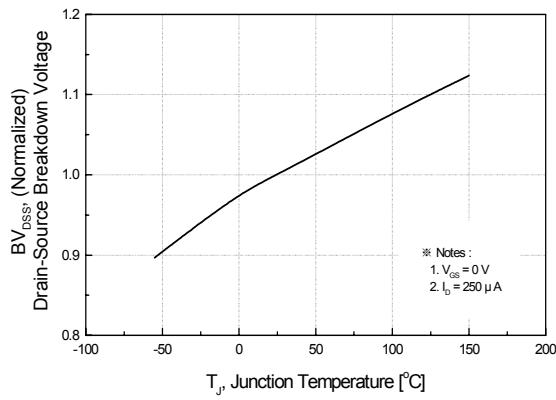


Figure 8. On-Resistance Variation vs. Temperature

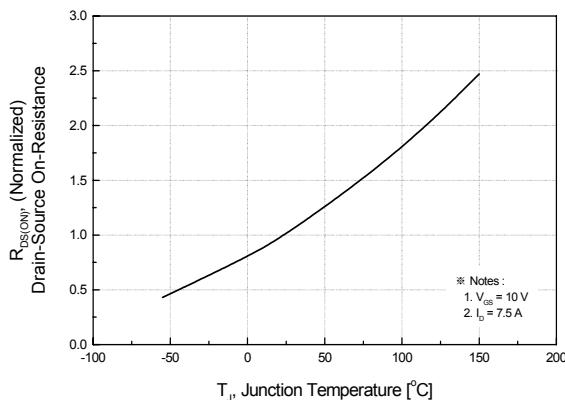


Figure 9-2. Safe Operating Area

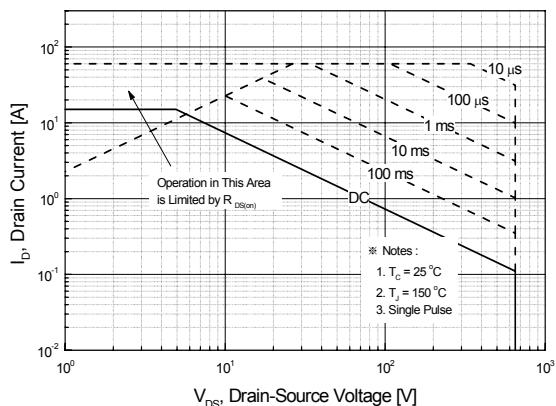


Figure 10. Maximum Drain Current vs. Case Temperature

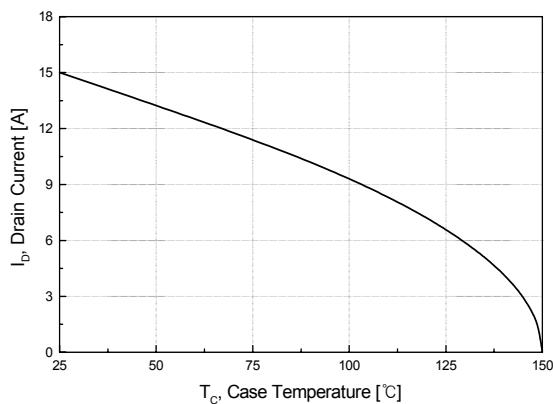
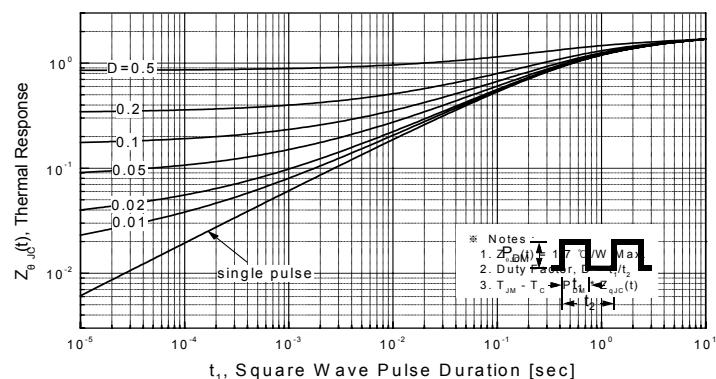
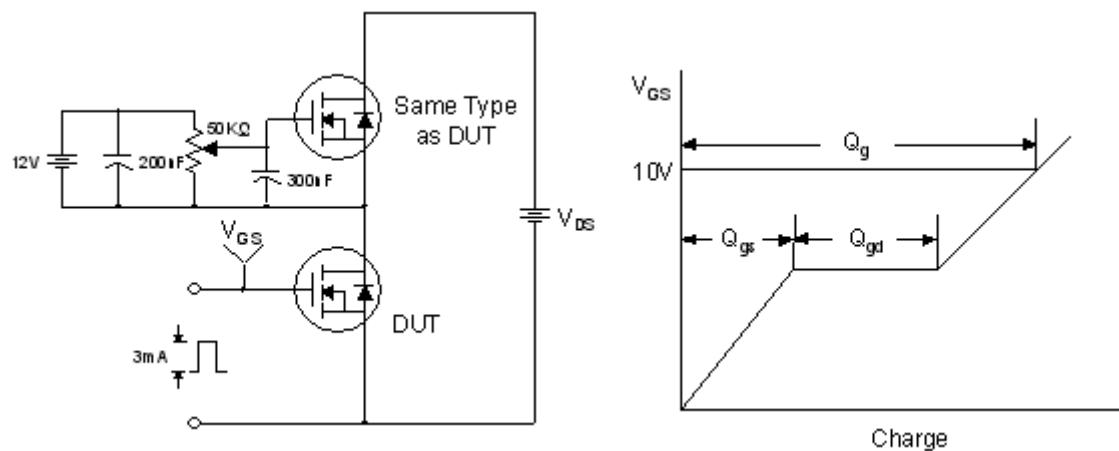


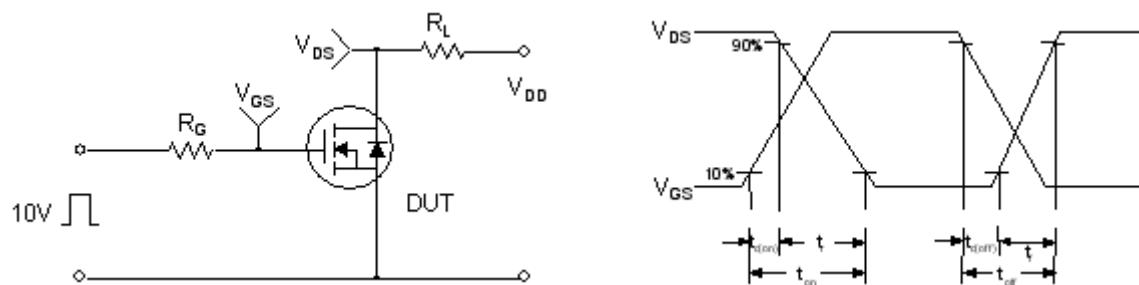
Figure 11-2. Transient Thermal Response Curve



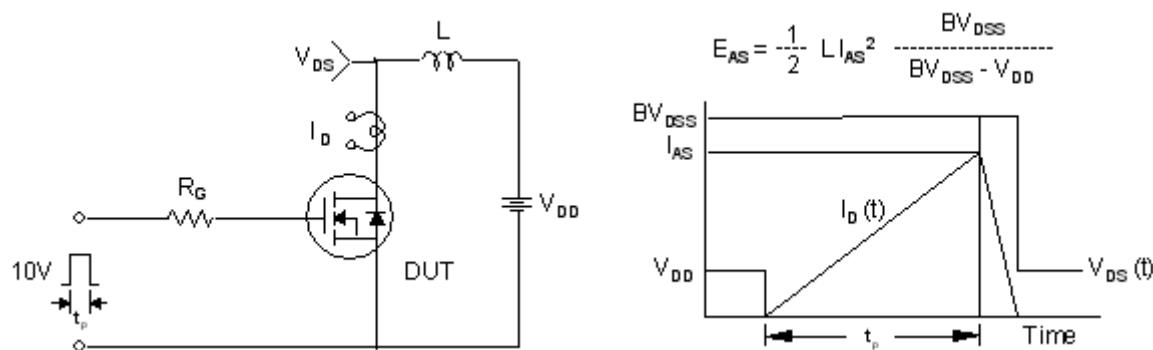
Gate Charge Test Circuit & Waveform



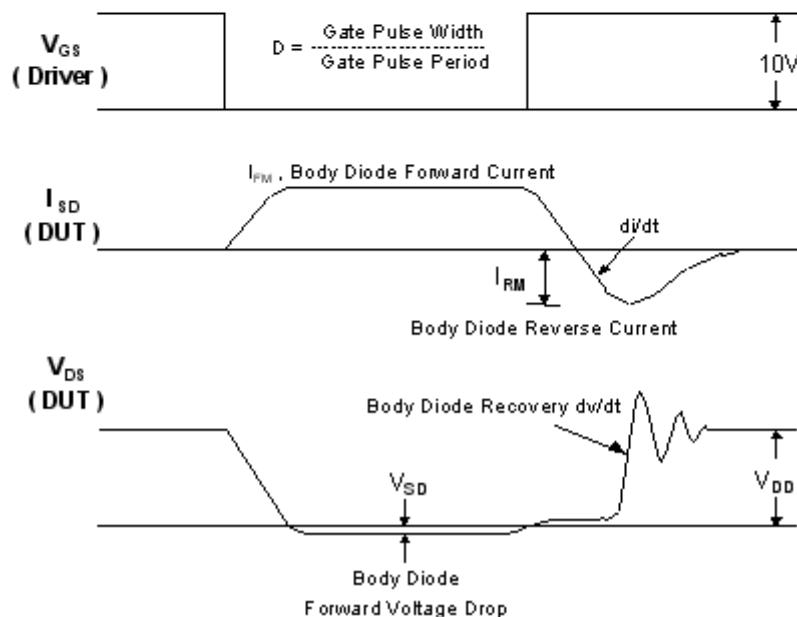
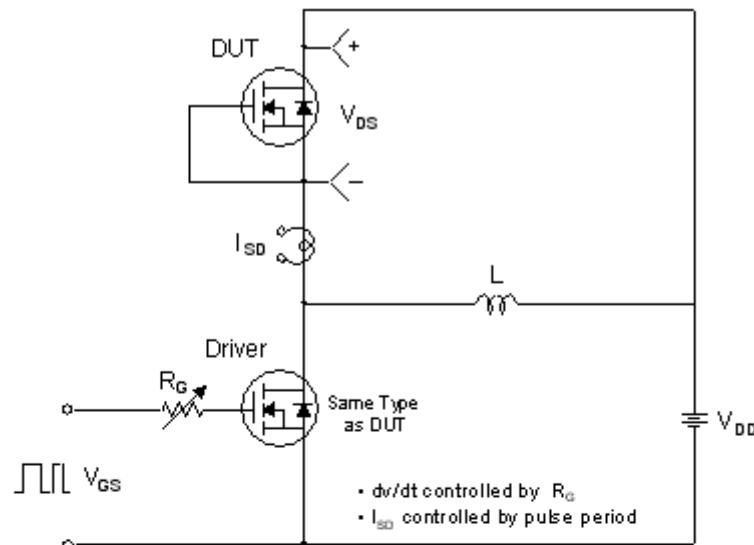
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

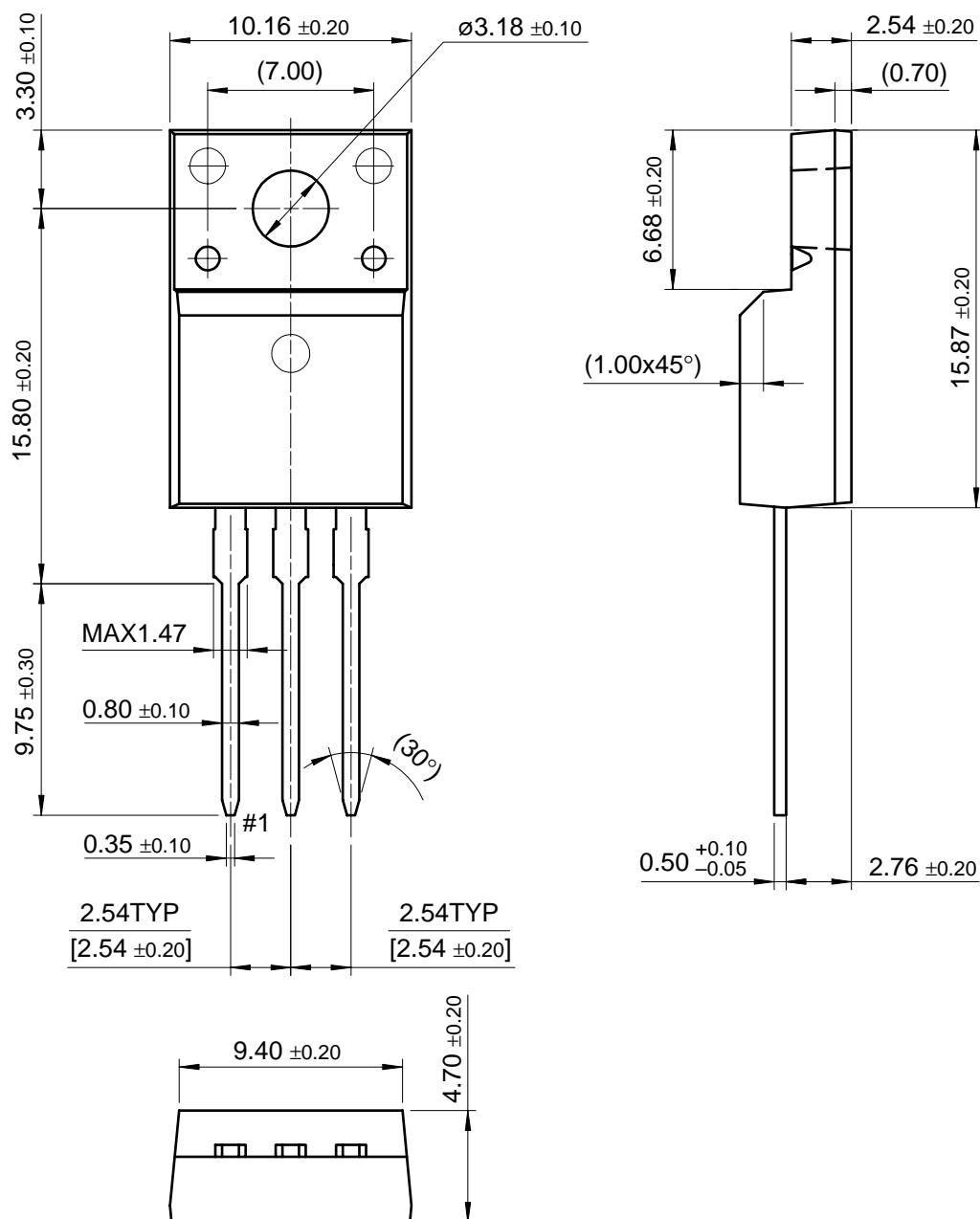


Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Dimension

TO-220F



Dimensions in Millimeters